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**Si4276DY**  
 Vishay Siliconix

## Dual N-Channel 30 V (D-S) MOSFET

PRODUCT SUMMARY				
	V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (Ω)	I <sub>D</sub> (A) <sup>a</sup>	Q <sub>g</sub> (Typ.)
Channel 1	30	0.0153 at V <sub>GS</sub> = 10 V	8 <sup>e</sup>	8.4
		0.0184 at V <sub>GS</sub> = 4.5 V	8 <sup>e</sup>	
Channel 2	30	0.0280 at V <sub>GS</sub> = 10 V	8	3.6
		0.0340 at V <sub>GS</sub> = 4.5 V	7.1	

### FEATURES

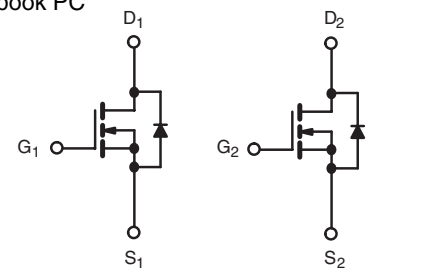
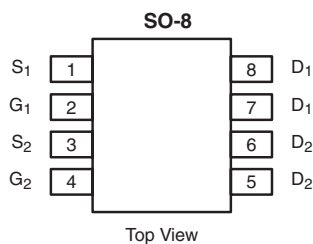
- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET<sup>®</sup> Power MOSFET
- 100 % R<sub>g</sub> Tested
- 100 % UIS Tested
- Compliant to RoHS Directive 2002/95/EC



**RoHS**  
 COMPLIANT  
 HALOGEN  
 FREE

### APPLICATIONS

- DC/DC for Notebook PC



Ordering Information: Si4276DY-T1-GE3 (Lead (Pb)-free and Halogen-free)

ABSOLUTE MAXIMUM RATINGS T <sub>A</sub> = 25 °C, unless otherwise noted				
Parameter	Symbol	Channel 1	Channel 2	Unit
Drain-Source Voltage	V <sub>DS</sub>	30		V
Gate-Source Voltage	V <sub>GS</sub>	± 20		
Continuous Drain Current (T <sub>J</sub> = 150 °C)	I <sub>D</sub>	T <sub>C</sub> = 25 °C	8 <sup>e</sup>	8
		T <sub>C</sub> = 70 °C	8 <sup>e</sup>	6.4
		T <sub>A</sub> = 25 °C	8 <sup>b, c, e</sup>	6.8 <sup>b, c</sup>
		T <sub>A</sub> = 70 °C	7.6 <sup>b, c</sup>	5.5 <sup>b, c</sup>
Pulsed Drain Current (10 μs Pulse Width)	I <sub>DM</sub>	50	30	A
Source-Drain Current Diode Current	I <sub>S</sub>	T <sub>C</sub> = 25 °C	3.0	
		T <sub>A</sub> = 25 °C	1.7 <sup>b, c</sup>	1.7 <sup>b, c</sup>
Single Pulse Avalanche Current	I <sub>AS</sub>	20	10	mJ
Avalanche Energy	E <sub>AS</sub>	20	5	
Maximum Power Dissipation	P <sub>D</sub>	T <sub>C</sub> = 25 °C	3.6	2.8
		T <sub>C</sub> = 70 °C	2.3	1.8
		T <sub>A</sub> = 25 °C	2.1 <sup>b, c</sup>	2.0 <sup>b, c</sup>
		T <sub>A</sub> = 70 °C	1.3 <sup>b, c</sup>	1.3 <sup>b, c</sup>
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150		°C

THERMAL RESISTANCE RATINGS						
Parameter	Symbol	Channel 1		Channel 2		Unit
		Typical	Maximum	Typical	Maximum	
Maximum Junction-to-Ambient <sup>b, d</sup>	R <sub>thJA</sub>	47	60	58	62.5	°C/W
Maximum Junction-to-Foot (Drain)	R <sub>thJF</sub>	30	35	38	45	

Notes:

- Based on T<sub>C</sub> = 25 °C.
- Surface mounted on 1" x 1" FR4 board.
- t = 10 s.
- Maximum under steady state conditions is 107 °C/W (Ch 1) and 110 °C/W (Ch 2).
- Package limited.

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<b>SPECIFICATIONS</b> $T_J = 25\text{ }^\circ\text{C}$ , unless otherwise noted							
Parameter	Symbol	Test Conditions	Min.	Typ. <sup>a</sup>	Max.	Unit	
<b>Static</b>							
Drain-Source Breakdown Voltage	$V_{DS}$	$V_{GS} = 0\text{ V}, I_D = 250\text{ }\mu\text{A}$	Ch 1	30		V	
		$V_{GS} = 0\text{ V}, I_D = 250\text{ }\mu\text{A}$	Ch 2	30			
$V_{DS}$ Temperature Coefficient	$\Delta V_{DS}/T_J$	$I_D = 250\text{ }\mu\text{A}$	Ch 1	29		mV/°C	
		$I_D = 250\text{ }\mu\text{A}$	Ch 2	30			
$V_{GS(th)}$ Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	$I_D = 250\text{ }\mu\text{A}$	Ch 1	- 5.2		mV/°C	
		$I_D = 250\text{ }\mu\text{A}$	Ch 2	- 4.4			
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\text{ }\mu\text{A}$	Ch 1	1.2	2.5	V	
		$V_{DS} = V_{GS}, I_D = 250\text{ }\mu\text{A}$	Ch 2	1.2	2.5		
Gate-Body Leakage	$I_{GSS}$	$V_{DS} = 0\text{ V}, V_{GS} = \pm 20\text{ V}$	Ch 1		100	nA	
			Ch 2		100		
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = 30\text{ V}, V_{GS} = 0\text{ V}$	Ch 1		1	$\mu\text{A}$	
		$V_{DS} = 30\text{ V}, V_{GS} = 0\text{ V}$	Ch 2		1		
		$V_{DS} = 30\text{ V}, V_{GS} = 0\text{ V}, T_J = 55\text{ }^\circ\text{C}$	Ch 1		10		
		$V_{DS} = 30\text{ V}, V_{GS} = 0\text{ V}, T_J = 55\text{ }^\circ\text{C}$	Ch 2		10		
On-State Drain Current <sup>b</sup>	$I_{D(on)}$	$V_{DS} = 5\text{ V}, V_{GS} = 10\text{ V}$	Ch 1	10		A	
		$V_{DS} = 5\text{ V}, V_{GS} = 10\text{ V}$	Ch 2	10			
Drain-Source On-State Resistance <sup>b</sup>	$R_{DS(on)}$	$V_{GS} = 10\text{ V}, I_D = 9.5\text{ A}$	Ch 1	0.0127	0.0153	$\Omega$	
		$V_{GS} = 10\text{ V}, I_D = 6.8\text{ A}$	Ch 2	0.0230	0.0280		
		$V_{GS} = 4.5\text{ V}, I_D = 8.7\text{ A}$	Ch 1	0.0146	0.0184		
		$V_{GS} = 4.5\text{ V}, I_D = 6.1\text{ A}$	Ch 2	0.0280	0.0340		
Forward Transconductance <sup>b</sup>	$g_{fs}$	$V_{DS} = 15\text{ V}, I_D = 9.5\text{ A}$	Ch 1	43		S	
		$V_{DS} = 15\text{ V}, I_D = 6.8\text{ A}$	Ch 2	17			
<b>Dynamic<sup>a</sup></b>							
Input Capacitance	$C_{iss}$	Channel 1 $V_{DS} = 15\text{ V}, V_{GS} = 0\text{ V}, f = 1\text{ MHz}$	Ch 1	1000		pF	
			Ch 2	366			
Output Capacitance	$C_{oss}$		Channel 2 $V_{DS} = 15\text{ V}, V_{GS} = 0\text{ V}, f = 1\text{ MHz}$	Ch 1	215		
				Ch 2	82		
Reverse Transfer Capacitance	$C_{rss}$	Ch 1		85			
		Ch 2		45			
Total Gate Charge	$Q_g$	$V_{DS} = 15\text{ V}, V_{GS} = 10\text{ V}, I_D = 9.5\text{ A}$	Ch 1	17.2	26	nC	
		$V_{DS} = 15\text{ V}, V_{GS} = 10\text{ V}, I_D = 6.8\text{ A}$	Ch 2	7.3	15		
		Channel 1 $V_{DS} = 15\text{ V}, V_{GS} = 4.5\text{ V}, I_D = 9.5\text{ A}$	Ch 1	8.4	17		
			Ch 2	3.6	8		
Gate-Source Charge	$Q_{gs}$	Channel 2 $V_{DS} = 15\text{ V}, V_{GS} = 4.5\text{ V}, I_D = 6.8\text{ A}$	Ch 1	3			
Gate-Drain Charge	$Q_{gd}$		Ch 2	1.1			
			Ch 1	2.6			
Ch 2	1.3						
Gate Resistance	$R_g$	$f = 1\text{ MHz}$	Ch 1	0.6	3.1	6.2	$\Omega$
			Ch 2	0.5	2.6	5.2	



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SPECIFICATIONS $T_J = 25\text{ }^\circ\text{C}$ , unless otherwise noted							
Parameter	Symbol	Test Conditions	Min.	Typ. <sup>a</sup>	Max.	Unit	
<b>Dynamic<sup>a</sup></b>							
Turn-On Delay Time	$t_{d(on)}$	Channel 1 $V_{DD} = 15\text{ V}, R_L = 2\ \Omega$ $I_D \cong 7.6\text{ A}, V_{GEN} = 10\text{ V}, R_g = 1\ \Omega$  Channel 2 $V_{DD} = 15\text{ V}, R_L = 2.7\ \Omega$ $I_D \cong 5.5\text{ A}, V_{GEN} = 10\text{ V}, R_g = 1\ \Omega$	Ch 1		8	16	ns
			Ch 2		4	8	
Rise Time	$t_r$		Ch 1		10	20	
			Ch 2		8	16	
Turn-Off Delay Time	$t_{d(off)}$		Ch 1		20	30	
			Ch 2		11	20	
Fall Time	$t_f$		Ch 1		7	14	
			Ch 2		7	14	
Turn-On Delay Time	$t_{d(on)}$	Ch 1		14	21		
		Ch 2		8	16		
Rise Time	$t_r$	Ch 1		11	20		
		Ch 2		10	20		
Turn-Off Delay Time	$t_{d(off)}$	Ch 1		18	27		
		Ch 2		10	20		
Fall Time	$t_f$	Ch 1		7	14		
		Ch 2		7	14		
<b>Drain-Source Body Diode Characteristics</b>							
Continuous Source-Drain Diode Current	$I_S$	$T_C = 25\text{ }^\circ\text{C}$	Ch 1			3	A
			Ch 2			2.3	
Pulse Diode Forward Current <sup>a</sup>	$I_{SM}$		Ch 1			50	
			Ch 2			30	
Body Diode Voltage	$V_{SD}$	$I_S = 7.6\text{ A}$ $I_S = 5.5\text{ A}$	Ch 1		0.82	1.2	V
			Ch 2		0.85	1.2	
Body Diode Reverse Recovery Time	$t_{rr}$	Channel 1 $I_F = 7.7\text{ A}, di/dt = 100\text{ A}/\mu\text{s}, T_J = 25\text{ }^\circ\text{C}$  Channel 2 $I_F = 5.5\text{ A}, di/dt = 100\text{ A}/\mu\text{s}, T_J = 25\text{ }^\circ\text{C}$	Ch 1		20	30	ns
			Ch 2		13	20	
Body Diode Reverse Recovery Charge	$Q_{rr}$		Ch 1		12	20	nC
			Ch 2		6	12	
Reverse Recovery Fall Time	$t_a$		Ch 1		11		ns
			Ch 2		7		
Reverse Recovery Rise Time	$t_b$		Ch 1		9		
			Ch 2		6		

**Notes:**

- a. Guaranteed by design, not subject to production testing.  
 b. Pulse test; pulse width  $\leq 300\ \mu\text{s}$ , duty cycle  $\leq 2\%$ .

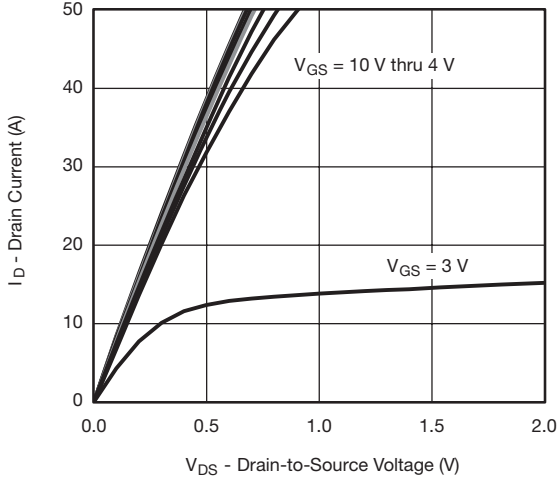
*Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.*

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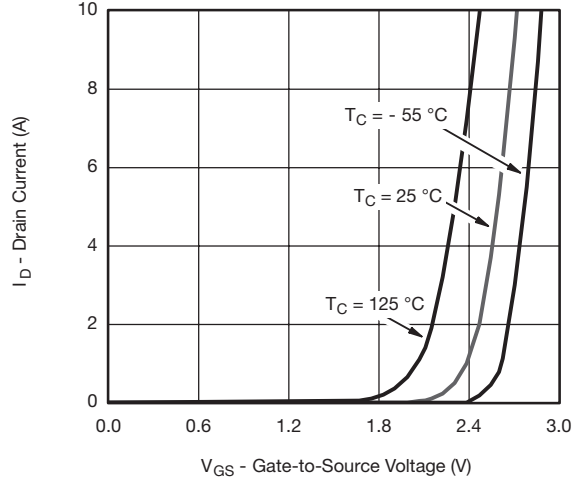
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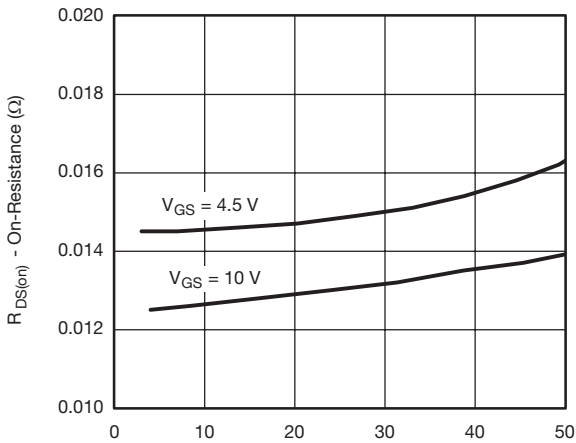
## CHANNEL-1 TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



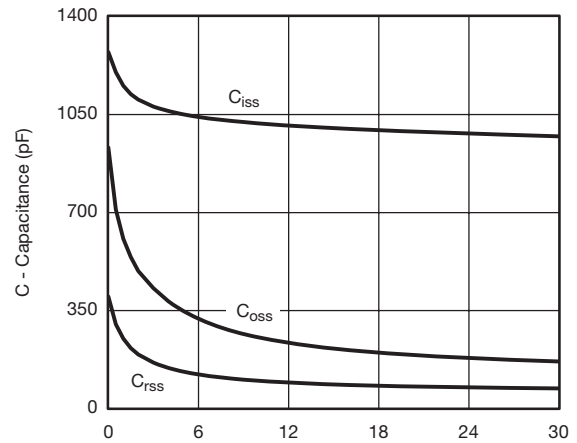
**Output Characteristics**



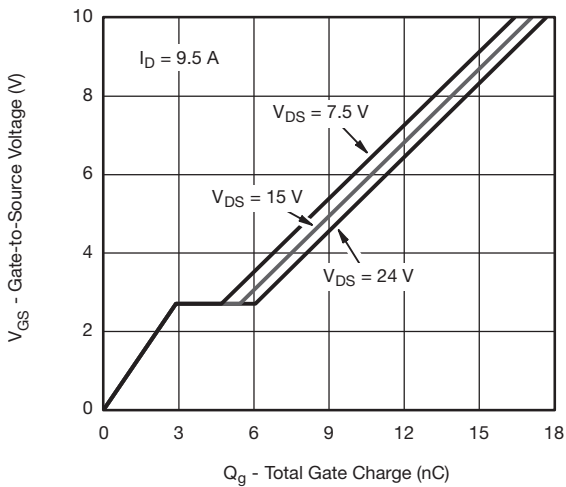
**Transfer Characteristics**



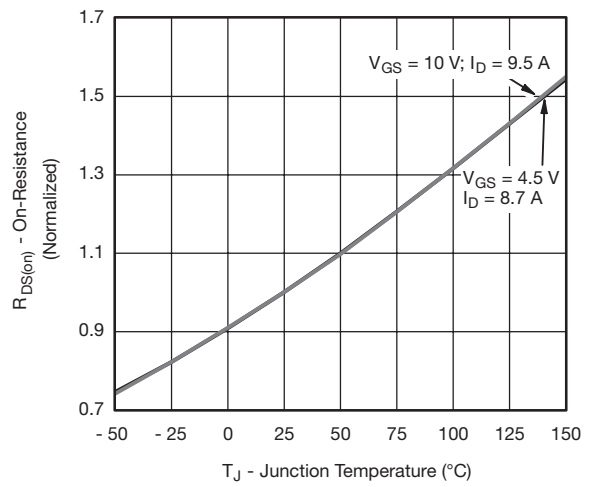
**On-Resistance vs. Drain Current**



**Capacitance**



**Gate Charge**

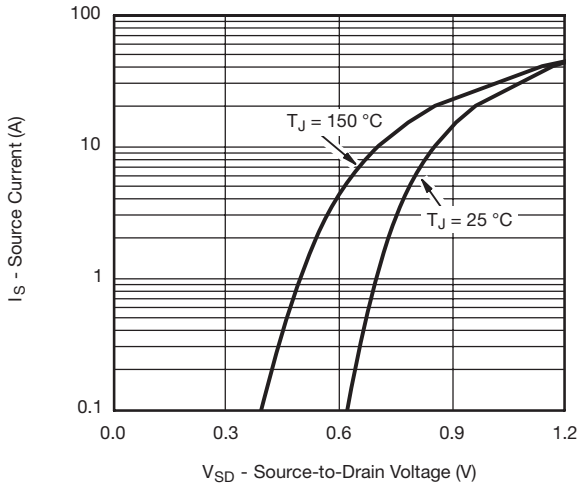


**On-Resistance vs. Junction Temperature**

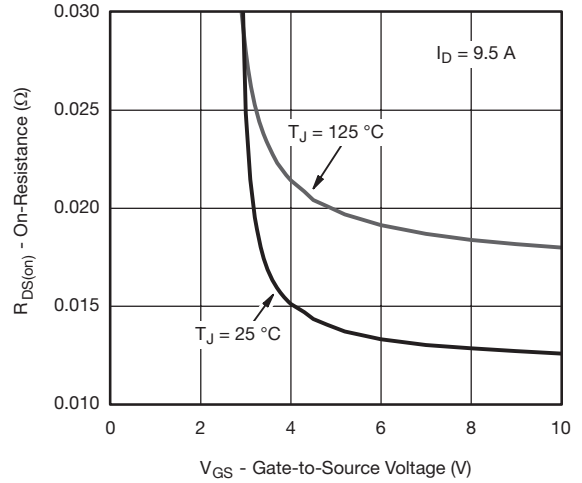


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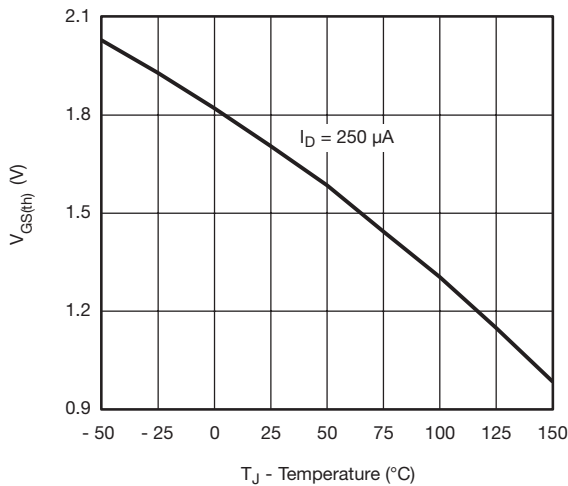
**CHANNEL-1 TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted



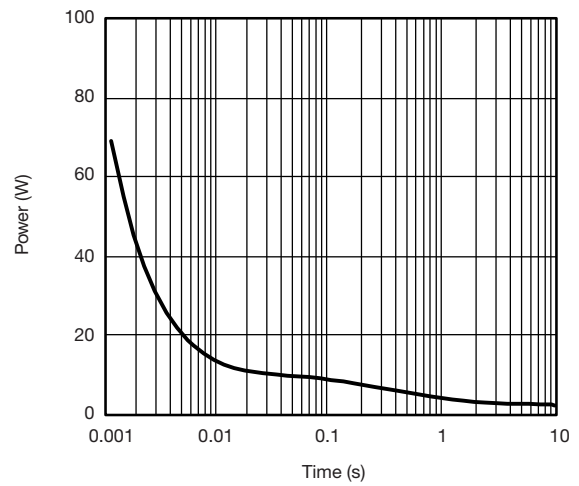
**Source-Drain Diode Forward Voltage**



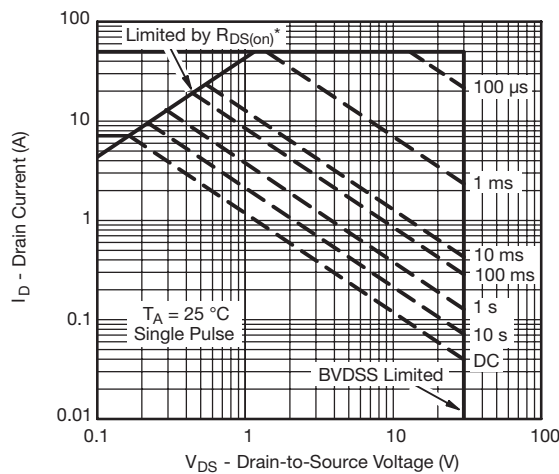
**On-Resistance vs. Gate-to-Source Voltage**



**Threshold Voltage**



**Single Pulse Power, Junction-to-Ambient**



\*  $V_{GS} >$  minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified

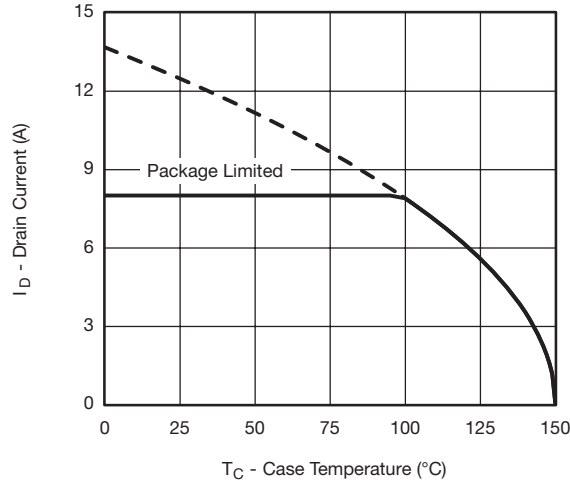
**Safe Operating Area, Junction-to-Ambient**

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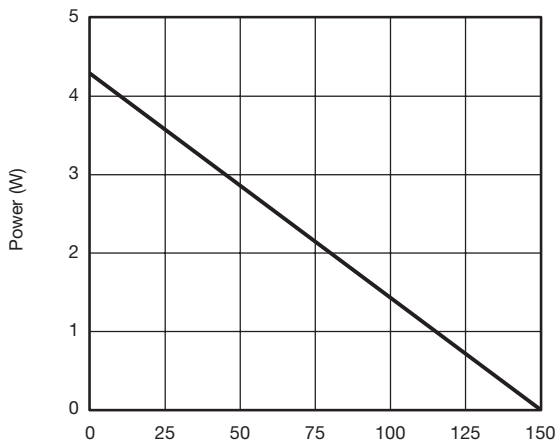


## CHANNEL-1 TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



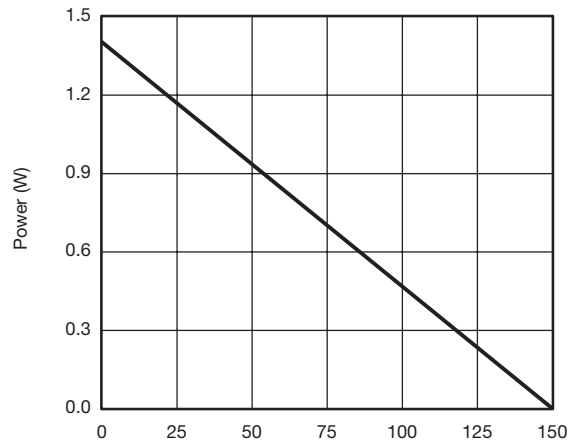
$T_C$  - Case Temperature (°C)

**Current Derating\***



$T_C$  - Case Temperature (°C)

**Power Derating, Junction-to-Foot**



$T_A$  - Ambient Temperature (°C)

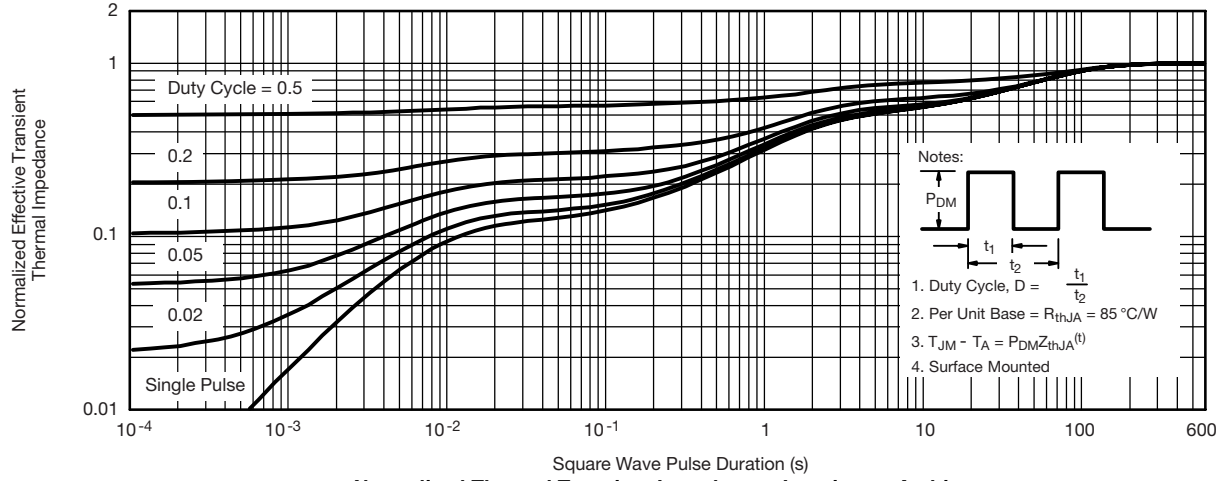
**Power Derating, Junction-to-Ambient**

\* The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

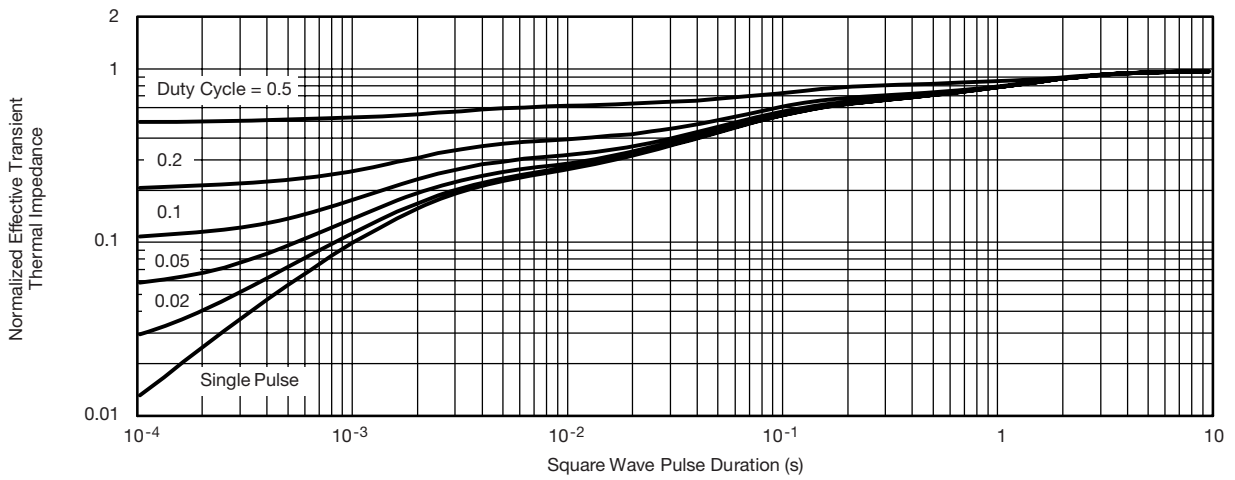


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**CHANNEL-1 TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted



**Normalized Thermal Transient Impedance, Junction-to-Ambient**



**Normalized Thermal Transient Impedance, Junction-to-Foot**

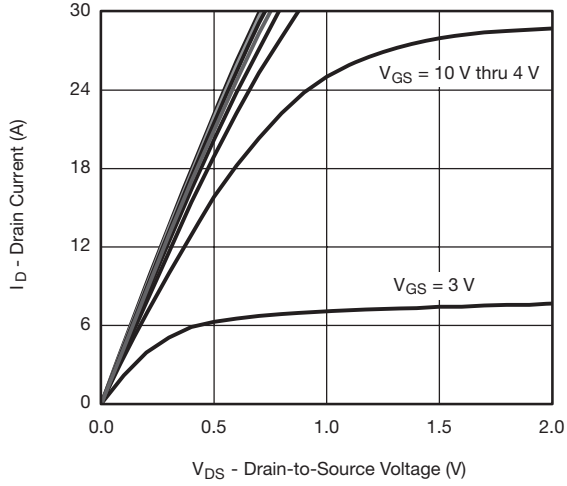


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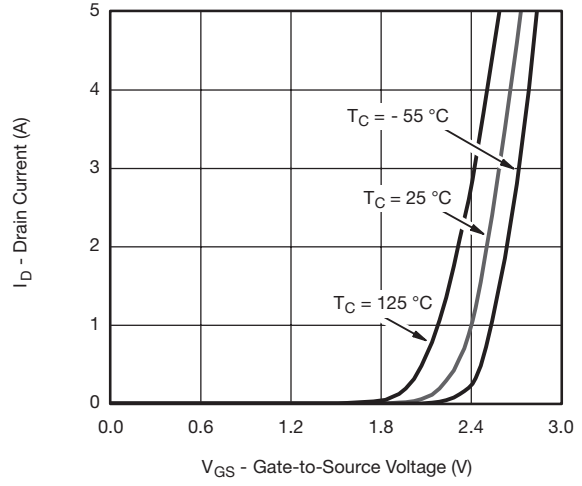
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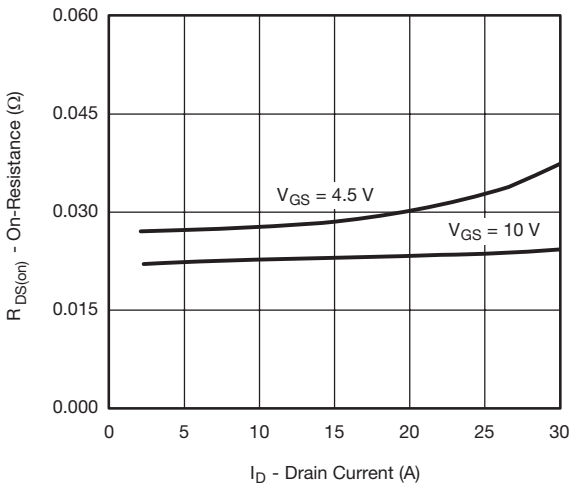
## CHANNEL-2 TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



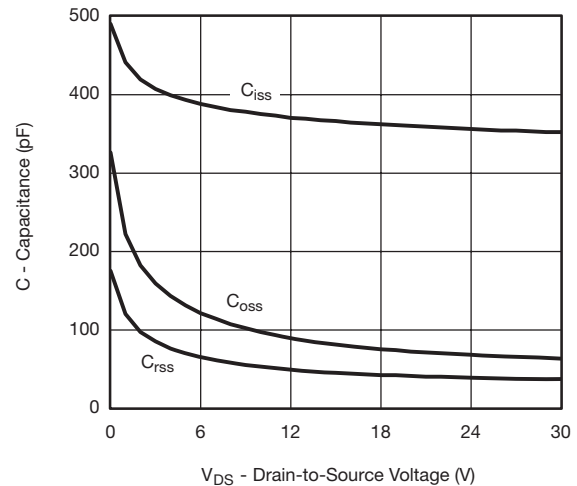
**Output Characteristics**



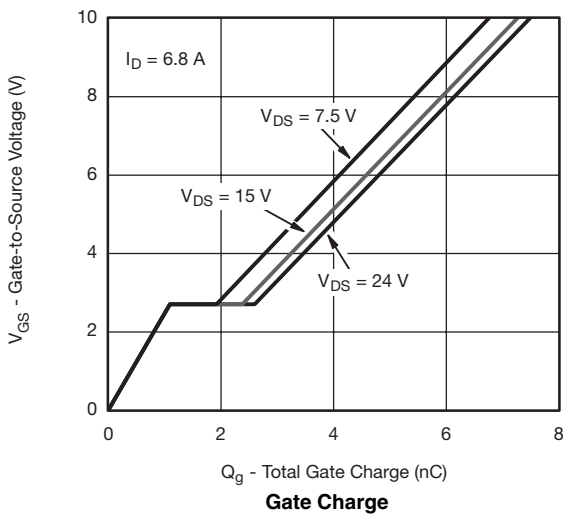
**Transfer Characteristics**



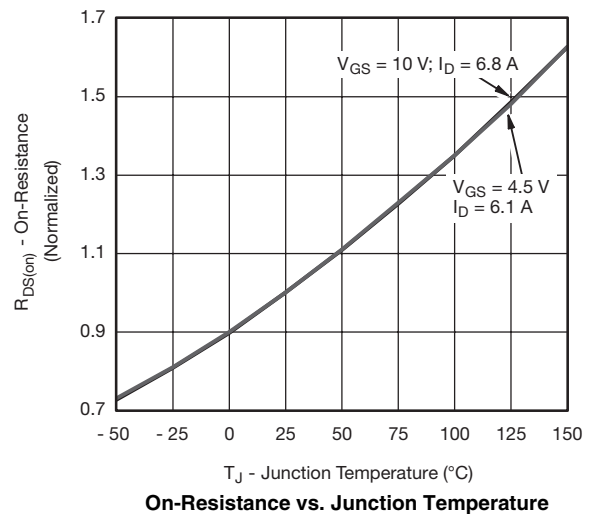
**On-Resistance vs. Drain Current**



**Capacitance**



**Gate Charge**

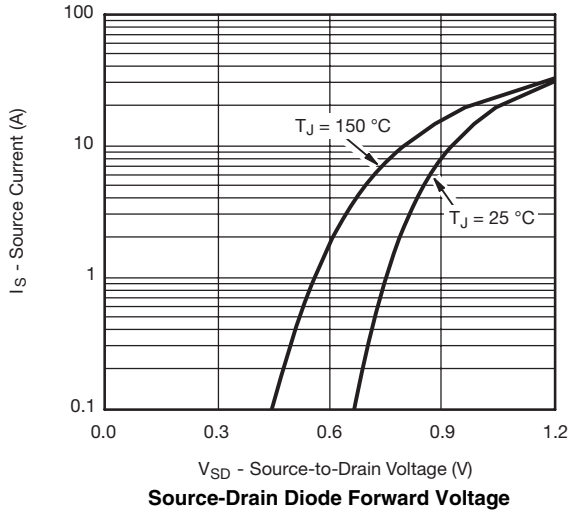


**On-Resistance vs. Junction Temperature**

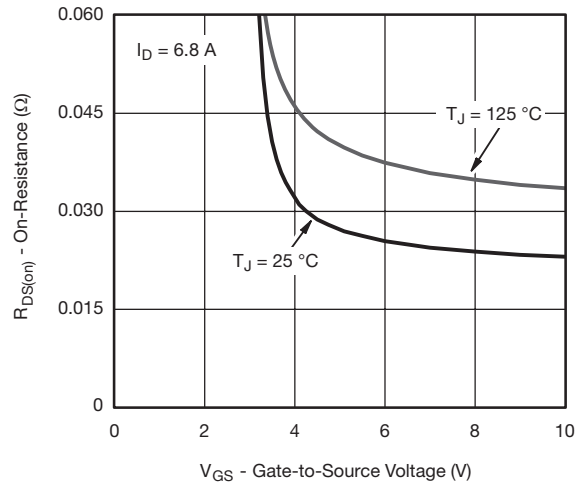


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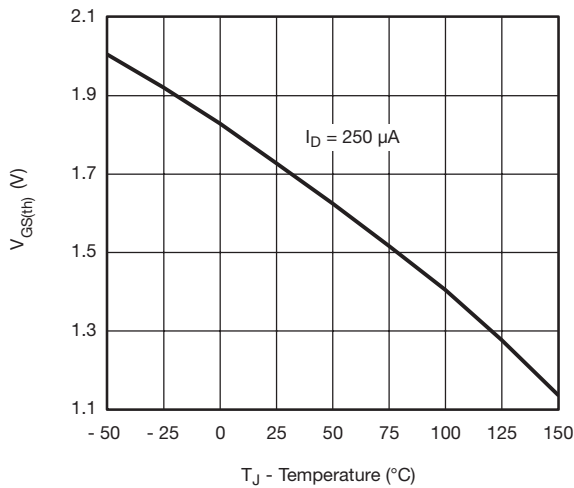
**CHANNEL-2 TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted



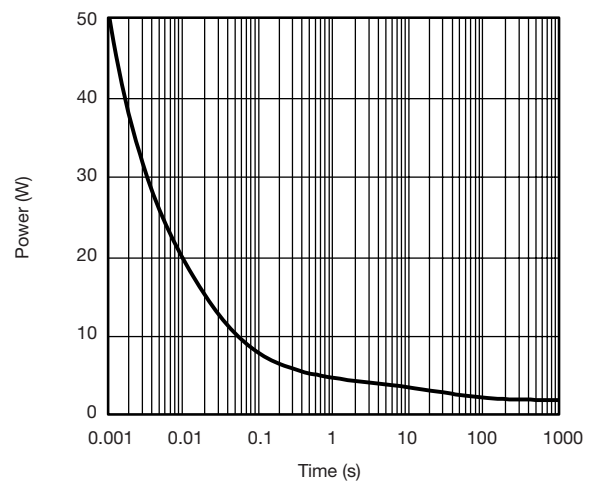
**Source-Drain Diode Forward Voltage**



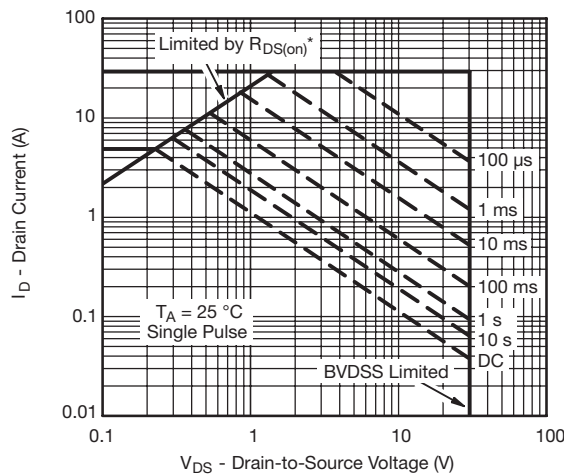
**On-Resistance vs. Gate-to-Source Voltage**



**Threshold Voltage**



**Single Pulse Power, Junction-to-Ambient**



\*  $V_{GS} >$  minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified

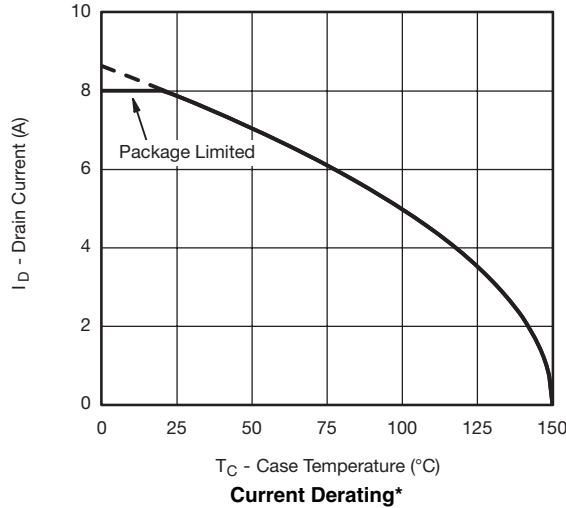
**Safe Operating Area, Junction-to-Ambient**

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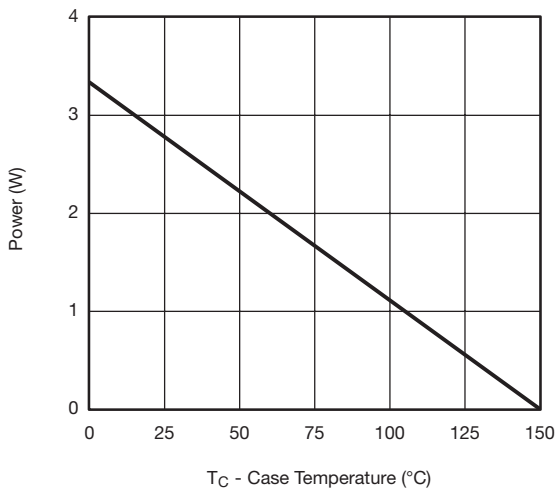
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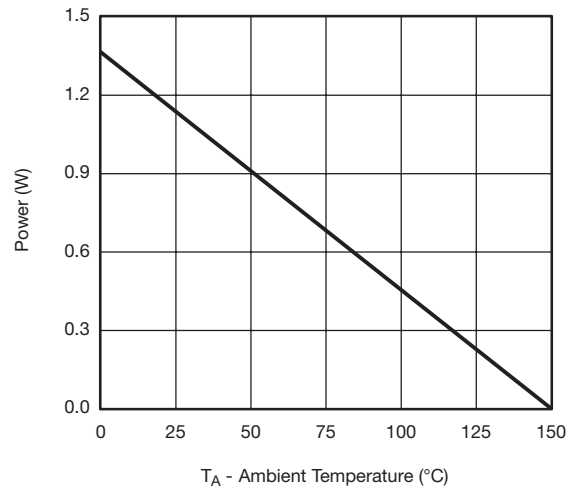
## CHANNEL-2 TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



**Current Derating\***



**Power Derating, Junction-to-Foot**



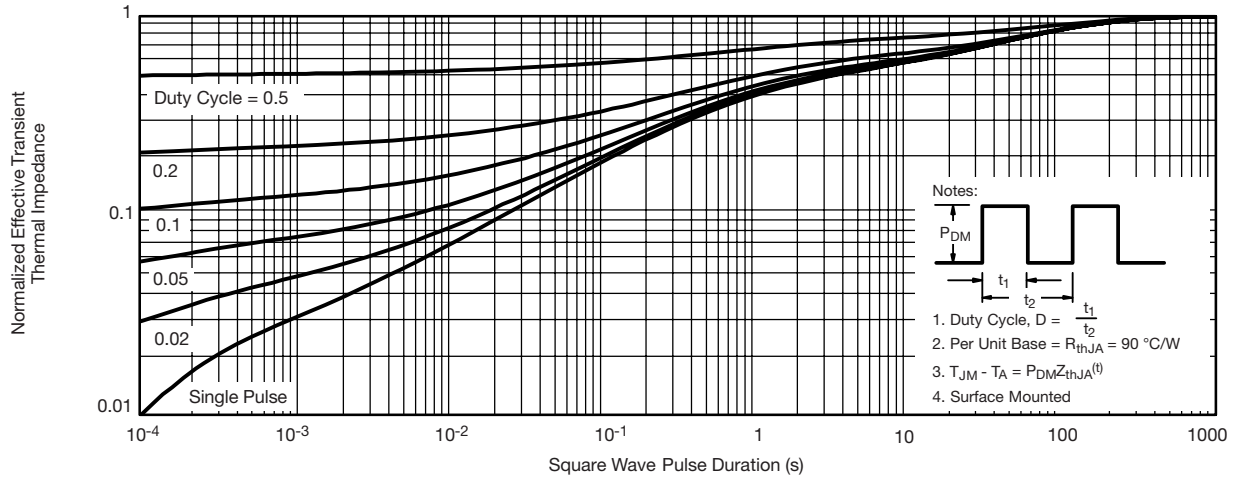
**Power Derating, Junction-to-Ambient**

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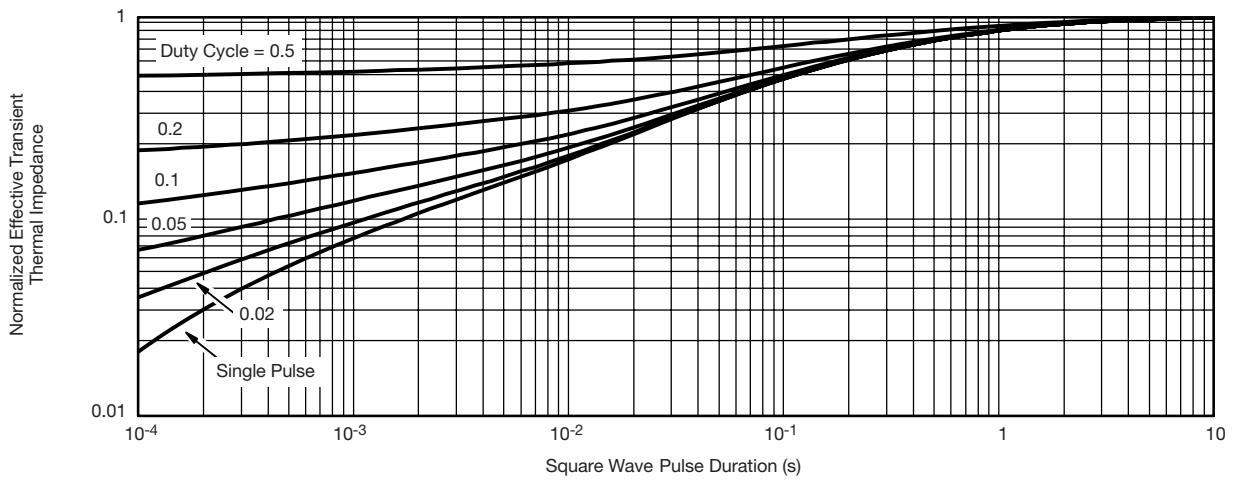


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**CHANNEL-2 TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted



**Normalized Thermal Transient Impedance, Junction-to-Ambient**



**Normalized Thermal Transient Impedance, Junction-to-Foot**

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see [www.vishay.com/ppg?66599](http://www.vishay.com/ppg?66599).



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